

CERAFLOUR 993

Micronized amide wax for powder coatings to improve degassing (Benzoin-Synergist).

Product Data

Composition

Micronized amide wax

Typical Properties

The values indicated in this data sheet describe typical properties and do not constitute specification limits.

Melting point:	145 °C	
Particle size distribution (laser diffraction, volume distribution):	D50: 13 µm	D90: 31 µm
Supplied as:	Micropowder	

Food Contact Legal Status

For the current food contact legal status, please contact our product safety department or visit www.byk.com for further information.

Storage and Transportation

Temperature sensitive. To be stored and transported at a temperature below 50 °C.

Applications

Powder Coatings

Special Features and Benefits

The additive improves the degassing and pigment wetting of powder coatings as well as the electrostatic charge during processing. It also has a matting effect.

Recommended Levels

0.5-2 % additive (as supplied) based upon total formulation.

The above recommended levels can be used for orientation. Optimal levels are determined through a series of laboratory tests.

Incorporation and Processing Instructions

The additive is mixed with resin, hardener, pigments and other additives in a high-speed mixer and then extruded together with all components.

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Additive Guide



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This information is given to the best of our knowledge. Because of the multitude of formulations, production, and application conditions, all the above-mentioned statements have to be adjusted to the circumstances of the processor. No liabilities, including those for patent rights, can be derived from this fact for individual cases.

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